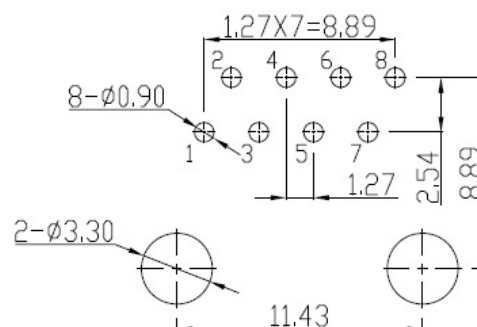
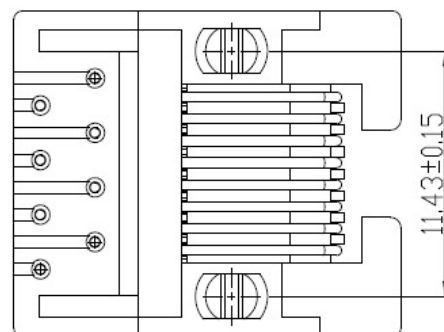
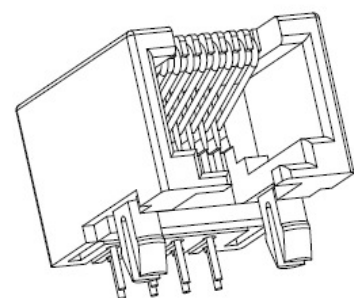
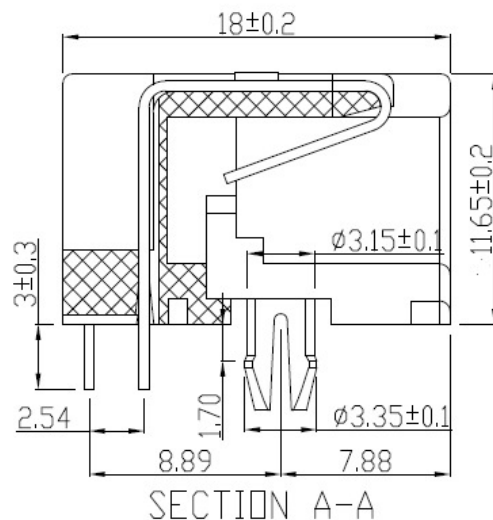
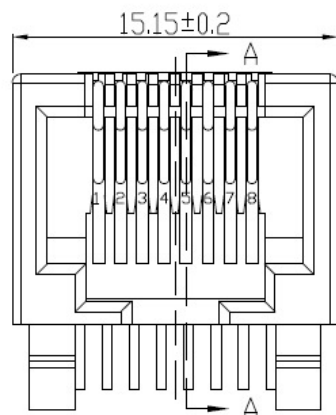




PC Board Layout

ELECTRICAL:

1. VOLTAGE RATING: 125 VAC RMS.
2. CURRENT RATING: 1.5 AMP.
3. CONTACT RESISTANCE: 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 500 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH: 1000 VAC RMS 50Hz or 60Hz, 1MIN.

MECHANICAL:

1. INSERT MATERIAL: UL94V-0.
2. CONTACT MATERIAL: PHOSPHOR BRONZE T=0.35MM.
3. PLATING: 1. CONTACT AREA-SELECTIVE GOLD PLATING.
: 2. TAILS PLATING TIN OVER NICKEL.
4. MATING/UNMATING FORCE: 2.2KG. F MAX.
5. RETENTION STRENGTH: 7.7KG. F MIN BETWEEN JACK AND PLUG.
6. OPERATING LIFE: 600 CYCLES MIN.

ENVIRONMENTAL:

1. STORAGE: -40°C ~ +85°C RELATIVE HUMIDITY<70%.
2. OPERATION: -40°C ~ +85°C.

Part code: JP-OE-8P8C

Description: RJ45 low profile modular jack

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DRAWING NOT TO SCALE